

# NGTB45N60S2WG

## IGBT - Inverter Welding

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for welding applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

### Features

- Low Switching Loss Reduces System Power Dissipation
- $T_{Jmax} = 175^{\circ}C$
- Soft, Fast Free Wheeling Diode
- This is a Pb-Free Device

### Typical Applications

- Welding

### ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	$V_{CES}$	600	V
Collector current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	$I_C$	90 45	A
Pulsed collector current, $T_{pulse}$ limited by $T_{Jmax}$	$I_{CM}$	180	A
Diode forward current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	$I_F$	90 45	A
Diode pulsed current, $T_{pulse}$ limited by $T_{Jmax}$	$I_{FM}$	180	A
Gate-emitter voltage Transient Gate Emitter Voltage ( $t_p = 5 \mu s$ , $D < 0.010$ )	$V_{GE}$	$\pm 20$ $\pm 30$	V
Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	$P_D$	300 150	W
Operating junction temperature range	$T_J$	-55 to +175	$^{\circ}C$
Storage temperature range	$T_{stg}$	-55 to +175	$^{\circ}C$
Lead temperature for soldering, 1/8" from case for 5 seconds	$T_{SLD}$	260	$^{\circ}C$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



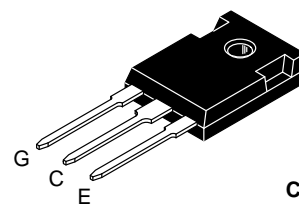
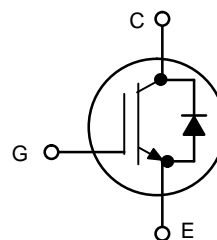
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**45 A, 600 V**

**$V_{CEsat} = 2.0 V$**

**$E_{off} = 0.36 mJ$**



TO-247  
CASE 340AL

### MARKING DIAGRAM



A = Assembly Location  
Y = Year  
WW = Work Week  
G = Pb-Free Package

### ORDERING INFORMATION

Device	Package	Shipping
NGTB45N60S2WG	TO-247 (Pb-Free)	30 Units / Rail

# NGTB45N60S2WG

## THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{\theta JC}$	0.50	°C/W
Thermal resistance junction-to-case, for Diode	$R_{\theta JC}$	1.46	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

## ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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### STATIC CHARACTERISTIC

Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0\text{ V}, I_C = 500\ \mu\text{A}$	$V_{(BR)CES}$	600	–	–	V
Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 45\text{ A}$ $V_{GE} = 15\text{ V}, I_C = 45\text{ A}, T_J = 175^\circ\text{C}$	$V_{CEsat}$	–	2.0 2.5	2.3 –	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 150\ \mu\text{A}$	$V_{GE(th)}$	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate-emitter short-circuited	$V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}$ $V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}, T_J = 175^\circ\text{C}$	$I_{CES}$	–	–	0.2 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}$	$I_{GES}$	–	–	100	nA

### DYNAMIC CHARACTERISTIC

Input capacitance	$V_{CE} = 20\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	$C_{ies}$	–	3200	–	pF
Output capacitance		$C_{oes}$	–	130	–	
Reverse transfer capacitance		$C_{res}$	–	85	–	
Gate charge total	$V_{CE} = 480\text{ V}, I_C = 45\text{ A}, V_{GE} = 15\text{ V}$	$Q_g$	–	135	–	nC
Gate to emitter charge		$Q_{ge}$	–	27	–	
Gate to collector charge		$Q_{gc}$	–	67	–	

### SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

Turn-off delay time	$T_J = 25^\circ\text{C}$ $V_{CC} = 400\text{ V}, I_C = 45\text{ A}$ $R_g = 10\ \Omega$ $V_{GE} = 0\text{ V}/15\text{ V}$	$t_{d(off)}$	–	151	–	ns
Fall time		$t_f$	–	55	–	
Turn-off switching loss		$E_{off}$	–	0.36	–	
Turn-off delay time	$T_J = 150^\circ\text{C}$ $V_{CC} = 400\text{ V}, I_C = 45\text{ A}$ $R_g = 10\ \Omega$ $V_{GE} = 0\text{ V}/15\text{ V}$	$t_{d(off)}$	–	154	–	ns
Fall time		$t_f$	–	78	–	
Turn-off switching loss		$E_{off}$	–	0.69	–	

### DIODE CHARACTERISTIC

Forward voltage	$V_{GE} = 0\text{ V}, I_F = 45\text{ A}$ $V_{GE} = 0\text{ V}, I_F = 45\text{ A}, T_J = 175^\circ\text{C}$	$V_F$	–	1.2 1.2	1.4 –	V
Reverse recovery time	$T_J = 25^\circ\text{C}$ $I_F = 45\text{ A}, V_R = 200\text{ V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$	$t_{rr}$	–	498	–	ns
Reverse recovery charge		$Q_{rr}$	–	9400	–	nc
Reverse recovery current		$I_{rrm}$	–	36	–	A

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# NGTB45N60S2WG

## TYPICAL CHARACTERISTICS

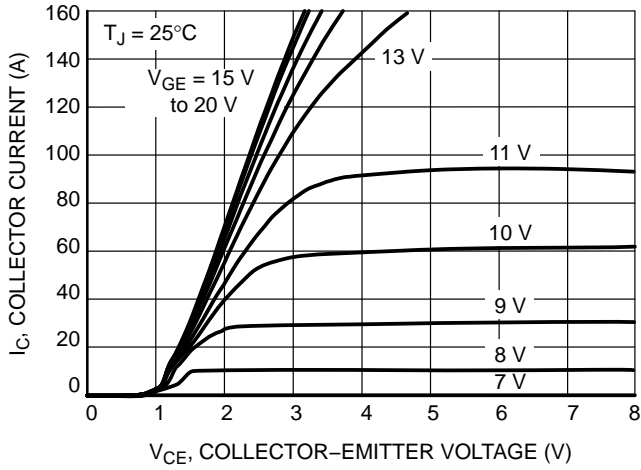


Figure 1. Output Characteristics

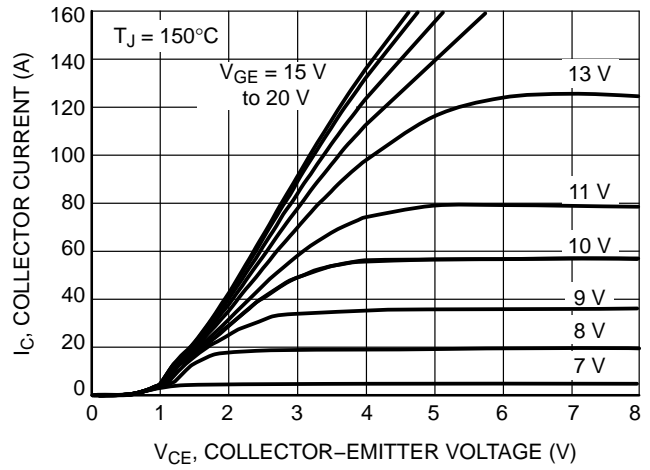


Figure 2. Output Characteristics

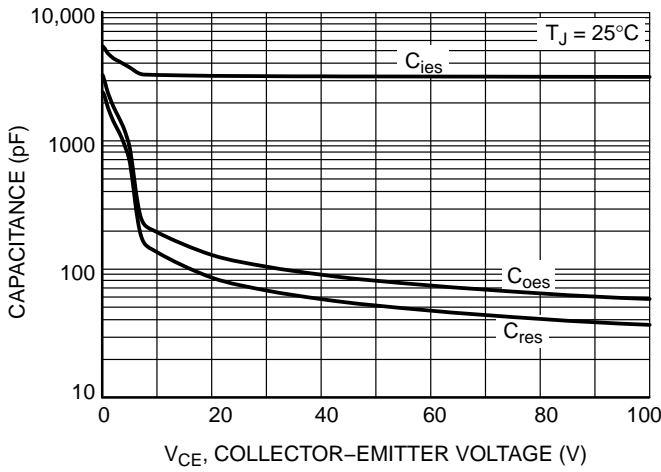


Figure 3. Typical Capacitance

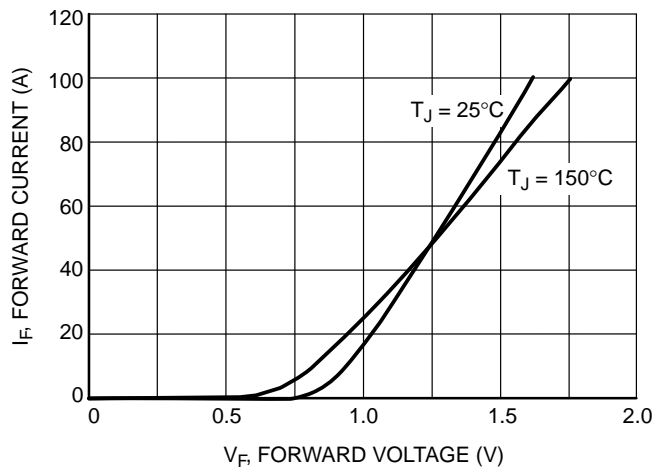


Figure 4. Diode Forward Characteristics

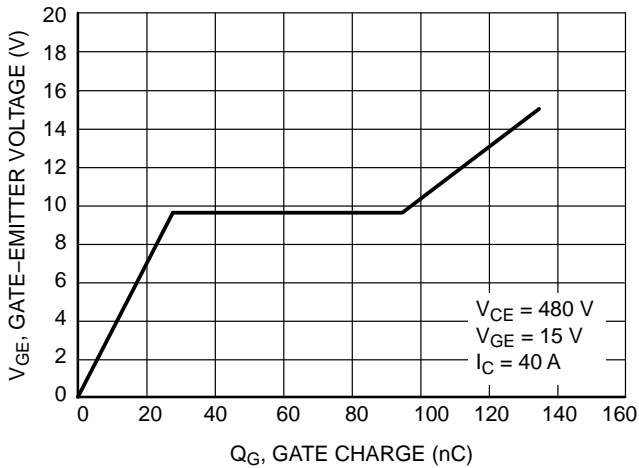


Figure 5. Typical Gate Charge

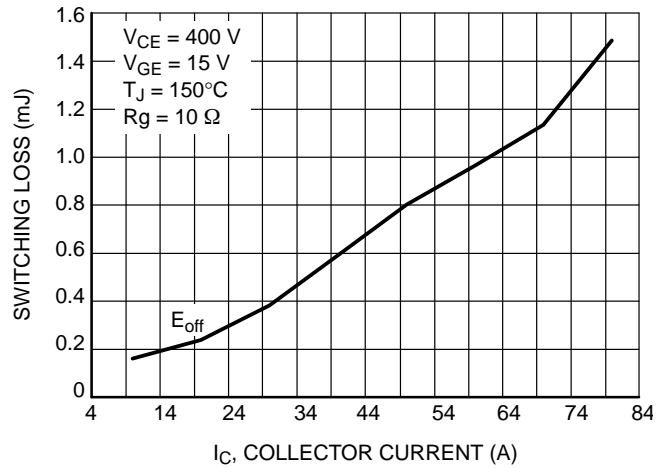


Figure 6. Switching Loss vs.  $I_C$

# NGTB45N60S2WG

## TYPICAL CHARACTERISTICS

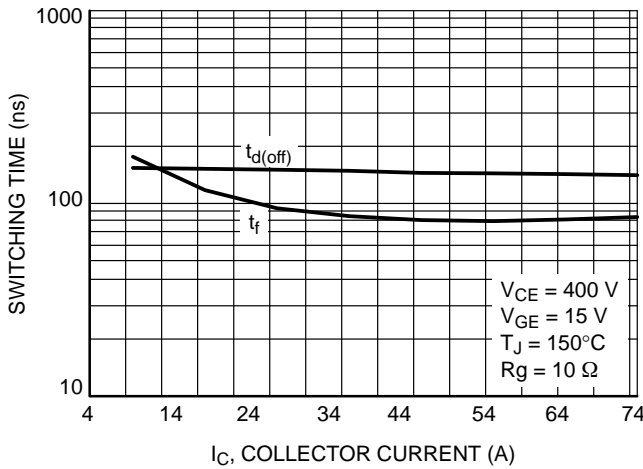


Figure 7. Switching Time vs.  $I_C$

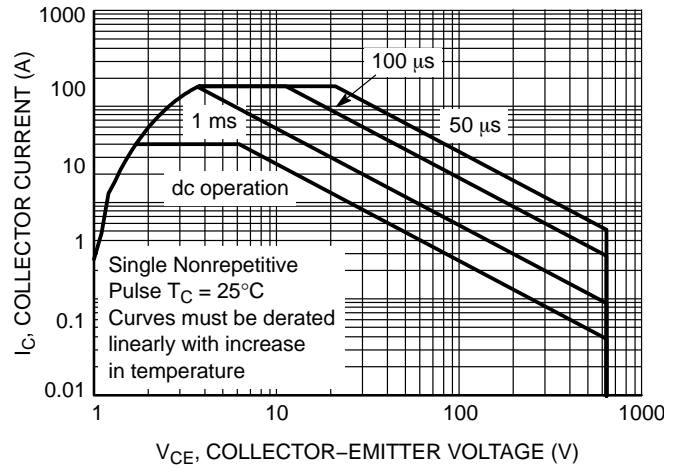


Figure 8. Safe Operating Area

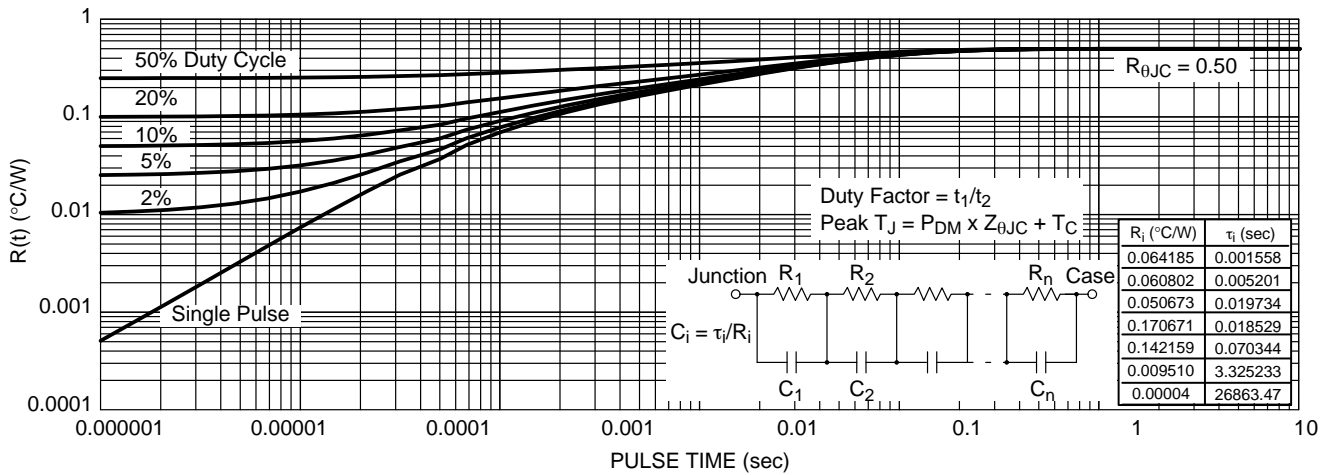


Figure 9. IGBT Transient Thermal Impedance

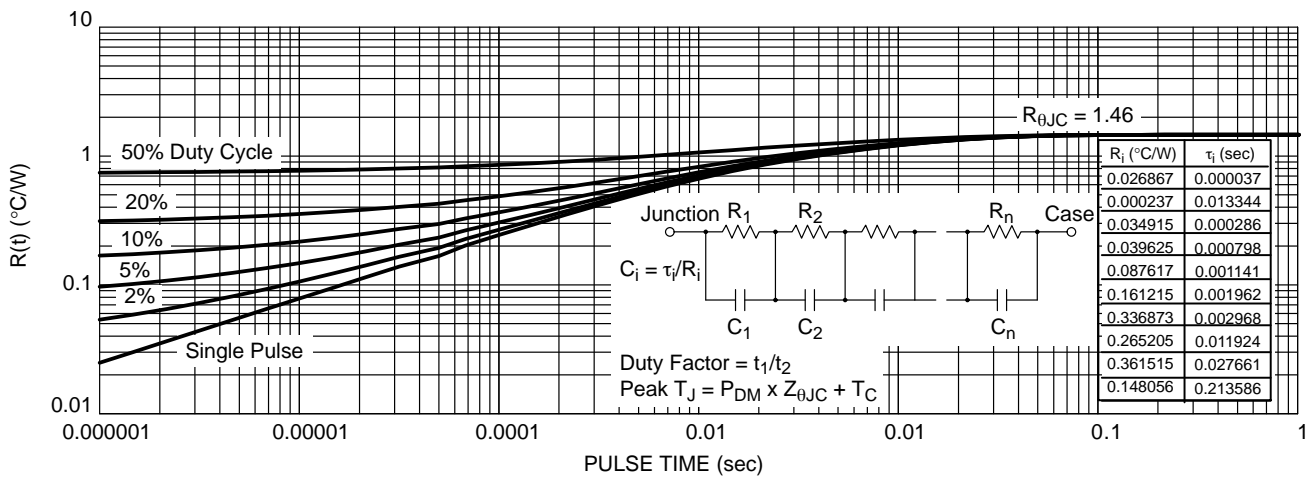


Figure 10. Diode Transient Thermal Impedance

# MECHANICAL CASE OUTLINE

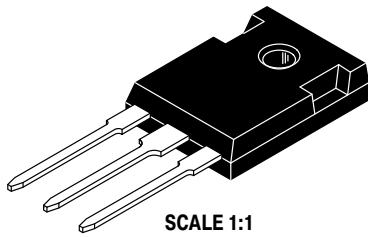
## PACKAGE DIMENSIONS

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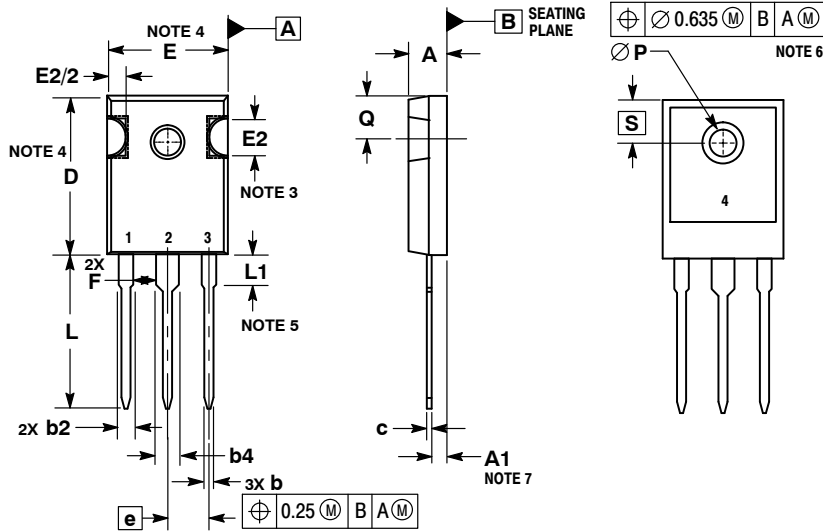


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DATE 17 MAR 2017



SCALE 1:1

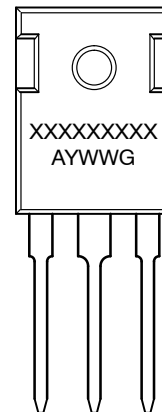


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. SLOT REQUIRED, NOTCH MAY BE ROUNDED.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
5. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.
6. ØP SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.
7. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.

MILLIMETERS		
DIM	MIN	MAX
A	4.70	5.30
A1	2.20	2.60
b	1.07	1.33
b2	1.65	2.35
b4	2.60	3.40
c	0.45	0.68
D	20.80	21.34
E	15.50	16.25
E2	4.32	5.49
e	5.45 BSC	
F	2.655	---
L	19.80	20.80
L1	3.81	4.32
P	3.55	3.65
Q	5.40	6.20
S	6.15 BSC	

### GENERIC MARKING DIAGRAM\*



- XXXXXX = Specific Device Code
- A = Assembly Location
- Y = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking.  
Pb-Free indicator, "G" or microdot "▪", may or may not be present.

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